Serial No.: 10/713,275

: November 17, 2003 Filed

Page : 2 of 9

Amendments to the Claims

This listing of claims replaces all prior versions and listings of claims in the application.

Listing of Claims

1-15. (Canceled)

- 16. (Currently Amended) An active matrix A circuit comprising:
- a transistor comprising a plurality of semiconductor islands;
- a semiconductor layer;
- a p-type impurity region provided in said semiconductor layer each of said semiconductor islands;
- a first interlayer insulating film comprising silicon nitride provided over said semiconductor layer semiconductor islands;
- a conductive layer comprising titanium and aluminum over said first interlayer insulating film; and
- a second interlayer insulating film provided over said conductive layer to provide a leveled upper surface over said semiconductor layer islands,
 - wherein said titanium and said aluminum are formed in a multi-layer film wherein each of said semiconductor islands has a planar area of $1000 \mu m^2$ or less.
- 17. (Currently Amended) A circuit according to claim 16 wherein said active matrix circuit is incorporated into a liquid-crystal display.
- 18. (Currently Amended) A circuit according to claim 16 wherein said active matrix circuit is incorporated into an image sensor.
- 19. (Currently Amended) A circuit according to claim 16 wherein said active matrix circuit is incorporated into a liquid-crystal electro-optical device.

Serial No.: 10/713,275

: November 17, 2003 Filed

: 3 of 9 Page

20. (Currently Amended) A circuit according to claim 16 wherein said semiconductor layer each of said semiconductor islands comprises a crystal silicon.

21. (Currently Amended) An active matrix circuit comprising:

a transistor comprising a plurality of semiconductor islands and provided in a pixel;

a semiconductor layer;

a p-type impurity region provided in said semiconductor layer each of said semiconductor islands;

a first interlayer insulating film comprising a silicon nitride layer and a silicon oxide layer, said first interlayer insulating film provided over said semiconductor layer islands;

a conductive layer comprising titanium and aluminum over said first interlayer insulating film; and

a second interlayer insulating film provided over said conductive layer to provide a leveled upper surface over said semiconductor layer islands; and

a pixel electrode provided over said second interlayer insulating film and connected with said p-type impurity region,

wherein each of said semiconductor islands has a planar area of 1000 μ m² or less.

- 22. (Previously Presented): A circuit according to claim 21 wherein said active matrix circuit is incorporated into a liquid-crystal display.
- 23. (Previously Presented): A circuit according to claim 21 wherein said active matrix circuit is incorporated into an image sensor.
- 24. (Previously Presented): A circuit according to claim 21 wherein said active matrix circuit is incorporated into a liquid-crystal electro-optical device.

Serial No.: 10/713,275

: November 17, 2003 Filed

Page : 4 of 9

25. (Currently Amended) A circuit according to claim 21 wherein said semiconductor layer each of said semiconductor islands comprises a crystal silicon.

26. (Currently Amended) An active matrix A drive circuit comprising: at least one transistor comprising a plurality of semiconductor islands; a semiconductor layer:

a p-type impurity region provided in said semiconductor layer each of said semiconductor islands;

a first interlayer insulating film comprising silicon nitride provided over said semiconductor layer islands;

a conductive layer comprising titanium and aluminum over said first interlayer insulating film; and

a second interlayer insulating film provided over said conductive layer to provide a leveled upper surface over said semiconductor layer islands, and

wherein each of said semiconductor islands has a planar area of 1000 µm² or less.

- 27. (Previously Presented): A circuit according to claim 26 wherein said conductive layer comprises an electrode.
- 28. (Previously Presented): A circuit according to claim 26 wherein said conductive layer comprises a wiring.
- 29. (Currently Amended) A circuit according to claim 26 wherein said active matrix drive circuit is incorporated into a liquid-crystal display.
- 30. (Currently Amended) A circuit according to claim 26 wherein said active matrix drive circuit is incorporated into an image sensor.

Serial No.: 10/713,275

: November 17, 2003 Filed

: 5 of 9 Page

31. (Currently Amended) A circuit according to claim 26 wherein said active matrix drive circuit is incorporated into a liquid-crystal electro-optical device.

- 32. (Currently Amended) A circuit according to claim 26 wherein said semiconductor layer each of said semiconductor islands comprises a crystal silicon.
 - 33. (Canceled).
 - 34. (Currently Amended) An active matrix A circuit comprising:
 - a transistor comprising a plurality of semiconductor islands;
 - a semiconductor layer;
- a p-type impurity region provided in said semiconductor layer each of said semiconductor islands;
- a first interlayer insulating film comprising silicon nitride provided over said semiconductor layer islan<u>ds</u>;
- a conductive layer comprising titanium and aluminum over said first interlayer insulating film, said conductive layer connected with said p-type impurity region; and
- a second interlayer insulating film provided over said conductive layer to provide a leveled upper surface over said semiconductor layer islands,

wherein said titanium and said aluminum are formed in a multi-layer film. wherein each of said semiconductor islands has a planar area of 1000 μm² or less.

- 35. (Currently Amended) A circuit according to claim 34 wherein said active matrix circuit is incorporated into a liquid-crystal display.
- 36. (Currently Amended) A circuit according to claim 34 wherein said active matrix circuit is incorporated into an image sensor.

Serial No.: 10/713,275

: November 17, 2003 Filed

Page : 6 of 9

37. (Currently Amended) A circuit according to claim 34 wherein said semiconductor laver each of said semiconductor islands comprises a crystal silicon.

38. (Currently Amended) An active matrix circuit comprising:

a transistor comprising a plurality of semiconductor islands;

a semiconductor layer;

a pair of p-type impurity region regions provided in said semiconductor layer each of said semiconductor islands;

a first interlayer insulating film comprising a silicon nitride layer and a silicon oxide layer, said first interlayer insulating film provided over said semiconductor layer islands;

a conductive layer comprising titanium and aluminum over said first interlayer insulating film, said conductive layer connected with one of said p-type impurity region regions; and

a second interlayer insulating film provided over said conductive layer to provide a leveled upper surface over said semiconductor layer islands; and

a pixel electrode provided over said second interlayer insulating film and connected with the other of said p-type impurity regions,

wherein each of said semiconductor islands has a planar area of $1000 \mu m^2$ or less.

- 39. (Previously Presented) A circuit according to claim 38 wherein said active matrix circuit is incorporated into a liquid-crystal display.
- 40. (Previously Presented) A circuit according to claim 38 wherein said active matrix circuit is incorporated into an image sensor.
- 41. (Currently Amended) A circuit according to claim 38 wherein said semiconductor layer each of said semiconductor islands comprises a crystal silicon.
 - 42. (Currently Amended) An active matrix A drive circuit comprising:

Serial No.: 10/713,275

: November 17, 2003 Filed

Page : 7 of 9

> at least one transistor comprising a plurality of semiconductor islands; a semiconductor layer:

a p-type impurity region provided in said semiconductor layer each of said semiconductor islands;

a first interlayer insulating film comprising silicon nitride provided over said semiconductor layer islands;

a conductive layer comprising titanium and aluminum over said first interlayer insulating film, said conductive layer connected with said p-type impurity region; and

a second interlayer insulating film provided over said conductive layer to provide a leveled upper surface over said semiconductor layer islands,

wherein each of said semiconductor islands has a planar area of 1000 µm² or less.

- 43. (Currently Amended) A circuit according to claim 42 wherein said active matrix drive circuit is incorporated into a liquid-crystal display.
- 44. (Currently Amended) A circuit according to claim 42 wherein said active matrix drive circuit is incorporated into an image sensor.
- 45. (Currently Amended) A circuit according to claim 42 wherein said semiconductor layer each of said semiconductor islands comprises a crystal silicon.